

2MBI75P-140

IGBT Module P-Series

1400V / 75A 2 in one-package

■ Features

- Small temperature dependence of the turn-off switching loss
- Easy to connect in parallel
- Wide RBSOA (square up to 2 time of rated current) and high short-circuit withstand capability
- Low loss and soft-switching (reduction of EMI noise)

■ Applications

- General purpose inverter
- AC and DC Servo drive amplifier
- Uninterruptible power supply

■ Maximum ratings and characteristics

● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item			Symbol	Conditions	Rating	Unit	
Collector-Emitter voltage			V _{CES}			1400	V
Gate-Emitter voltage			V _{GES}			±20	V
Collector current			I _c	Continuous	T _C =25°C	100	A
					T _C =80°C	75	
			I _{cp}	1ms	T _C =25°C	200	
					T _C =80°C	150	
					-I _c		
			-I _c pulse			150	
Collector Power Dissipation			P _C	1 device		600	W
Junction temperature			T _J			+150	°C
Storage temperature			T _{stg}			-40 to +125	
Isolation voltage	between terminal and copper base *1		V _{iso}	AC:1min.		2500	VAC
Screw Torque			Mounting *2			3.5	N·m
			Terminals *2			3.5	

*1 : All terminals should be connected together when isolation test will be done.

*2 : Recommendable value : 2.5 to 3.5 N·m(M5)

● Electrical characteristics (at T_j=25°C unless otherwise specified)

Item	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Zero gate voltage collector current	I _{CES}	V _{GE} =0V, V _{CE} =1400V	—	—	1.0	mA
Gate-Emitter leakage current	I _{GES}	V _{CE} =0V, V _{GE} =±20V	—	—	200	nA
Gate-Emitter threshold voltage	V _{GE(th)}	V _{CE} =20V, I _c =75mA	6.0	8.0	9.0	V
Collector-Emitter saturation voltage	V _{CE(sat)}	V _{GE} =15V, I _c =75A, T _j =25°C	—	2.7	3.0	V
		V _{GE} =15V, I _c =75A, T _j =125°C	—	3.3	—	
Input capacitance	C _{ies}	V _{CE} =10V	—	7500	—	pF
Output capacitance	C _{oes}	V _{GE} =0V	—	1000	—	
Reverse transfer capacitance	C _{res}	f=1MHz	—	500	—	
Turn-on time	t _{on}	V _{CC} =600V	—	—	1.20	μs
	t _r	I _c =75A	—	—	0.60	
Turn-off time	t _{off}	V _{GE} =±15V	—	—	1.00	
	t _f	R _G =16 Ω	—	—	0.30	
Diode forward on voltage	V _F	I _F =75A, V _{GE} =0V	—	2.4	3.3	V
Reverse recovery time	t _{rr}	I _F =75A	—	—	0.35	μs

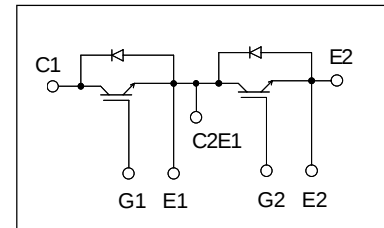
● Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	R _{th(j-c)}	IGBT	—	—	0.21	°C/W
	R _{th(j-c)}	Diode	—	—	0.47	°C/W
Contact Thermal resistance	R _{th(c-f)*4}	the base to cooling fin	—	0.05	—	°C/W

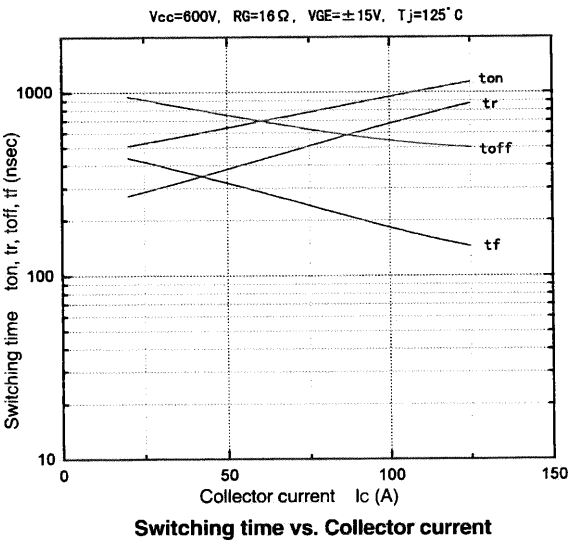
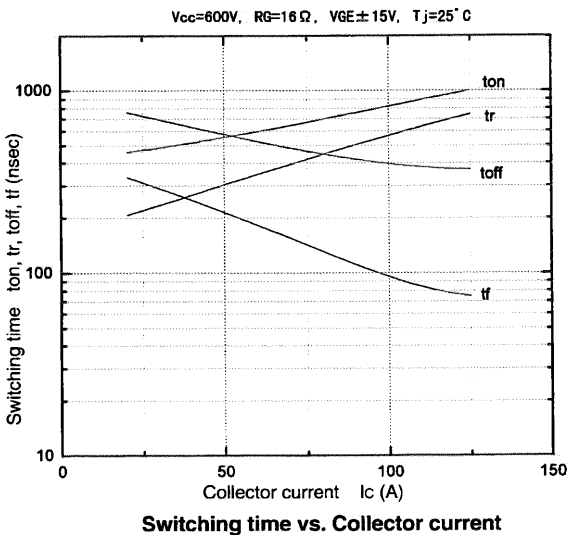
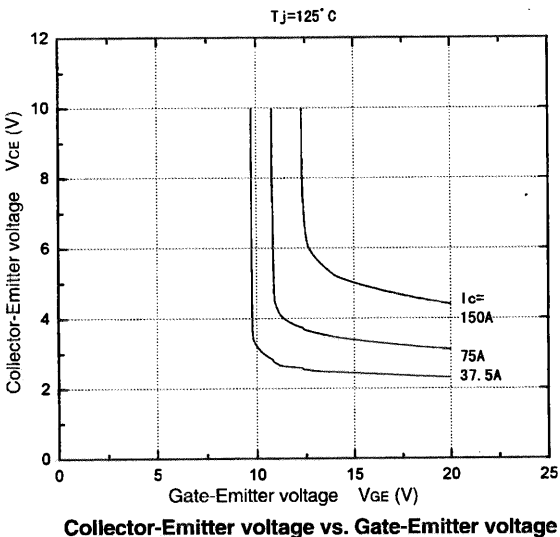
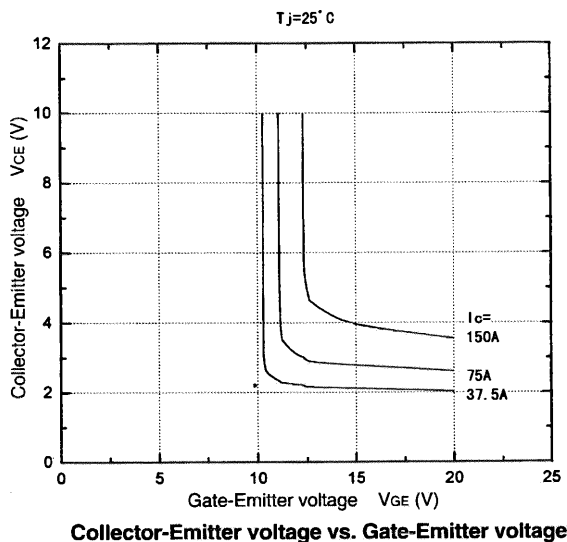
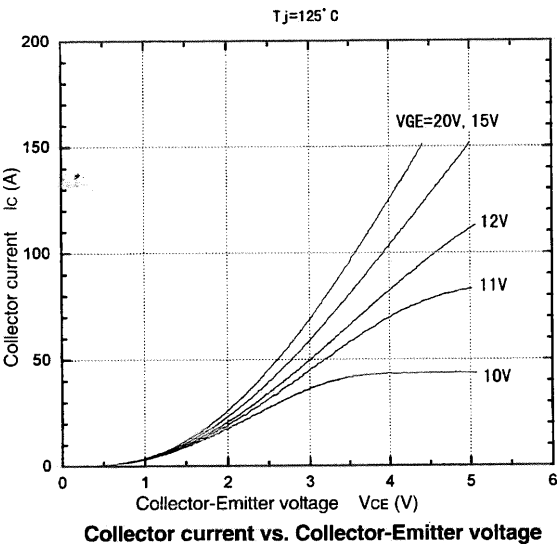
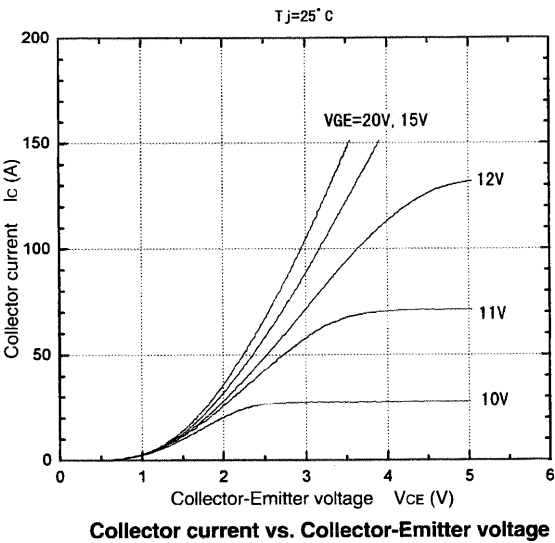
*4 : This is the value which is defined mounting on the additional cooling fin with thermal compound.

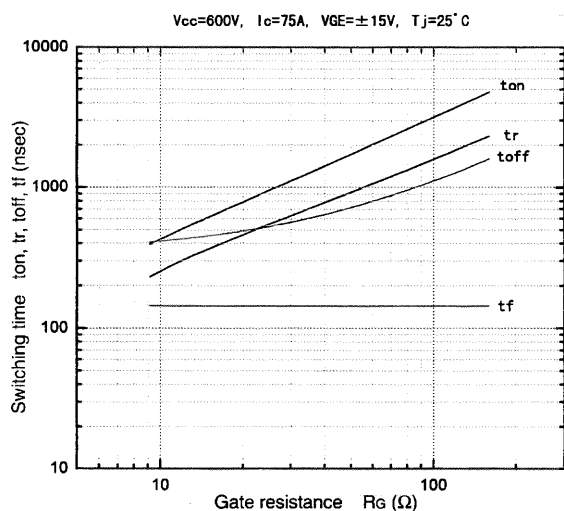


■ Equivalent Circuit Schematic

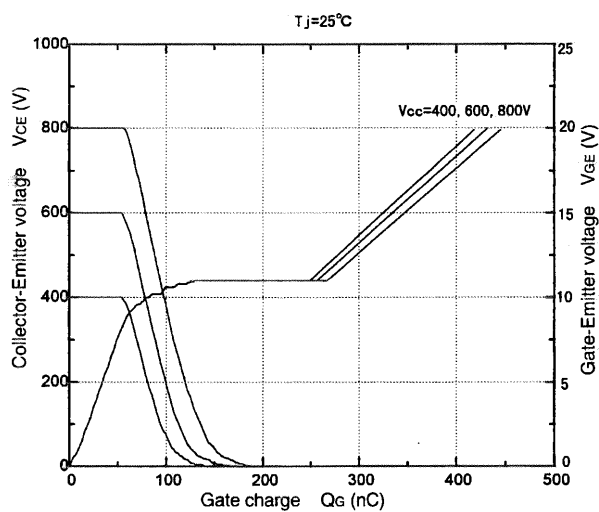


■ Characteristics (Representative)

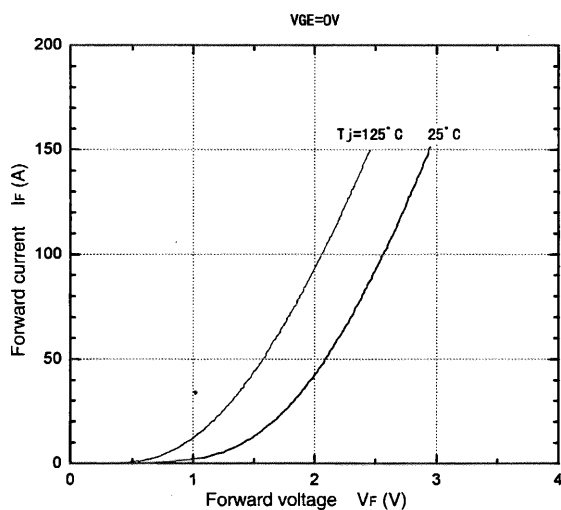




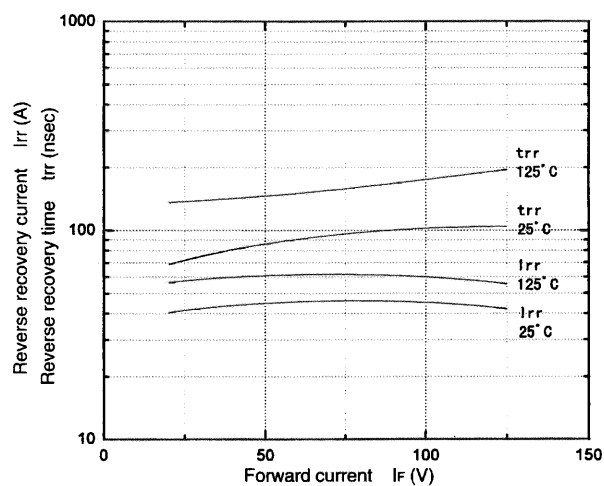
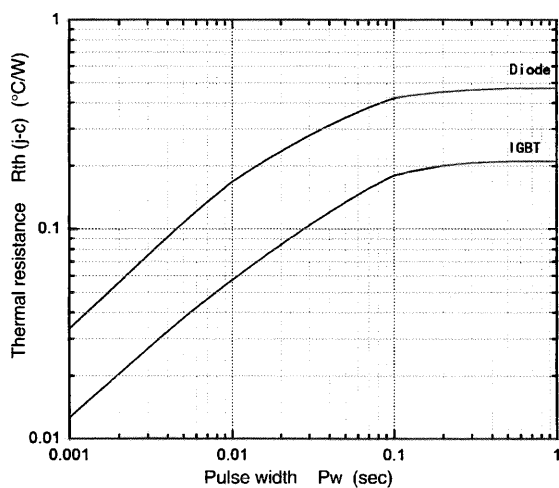
Switching time vs. Gate resistance



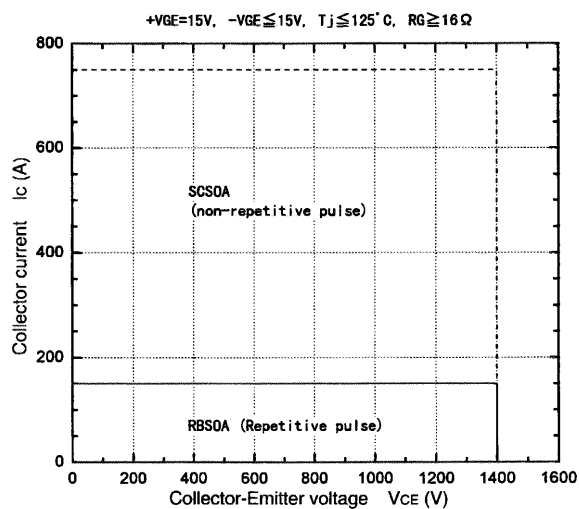
Dynamic input characteristics



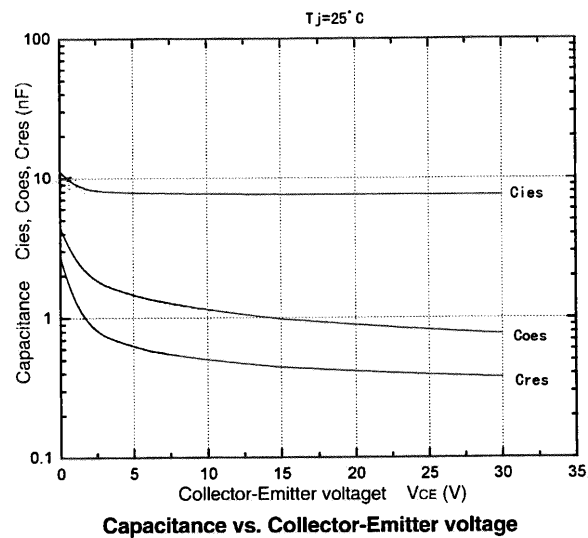
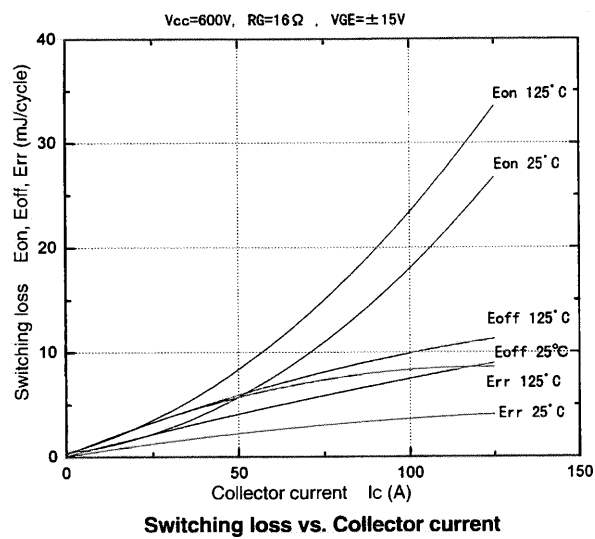
Forward current vs. Forward voltage

 T_{rr} , I_{rr} vs. I_F 

Transient thermal resistance



Reverse biased safe operating area



■ Outline Drawings, mm

M232

